

CD40160B, CD40161B, CD40162B, CD40163B Types

CMOS Synchronous Programmable 4-Bit Counters

High-Voltage Types (20-Volt Rating)

CD40160B – Decade with Asynchronous
Clear

CD40161B – Binary with Asynchronous
Clear

CD40162B – Decade with Synchronous
Clear

CD40163B – Binary with Synchronous
Clear

■ CD40160B, CD40161B, CD40162B, and CD40163B are 4-bit synchronous programmable counters. The CLEAR function of the CD40162B and CD40163B is synchronous and a low level at the CLEAR input sets all four outputs low on the next positive CLOCK edge. The CLEAR function of the CD40160B and CD40161B is asynchronous and a low level at the CLEAR input sets all four outputs low regardless of the state of the CLOCK, LOAD, or ENABLE inputs. A low level at the LOAD input disables the counter and causes the output to agree with the setup data after the next CLOCK pulse regardless of the conditions of the ENABLE inputs.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable inputs and a carry output (C_{OUT}). Counting is enabled when both PE and TE inputs are high. The TE input is fed forward to enable C_{OUT}. This enabled output produces a positive output pulse with a

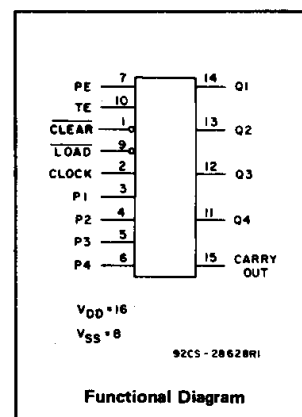
Features:

- Internal look-ahead for fast counting
- Carry output for cascading
- Synchronously programmable
- Clear asynchronous input (CD40160B, CD40161B)
- Clear synchronous input (CD40162B, CD40163B)
- Synchronous load control input
- Low-power TTL compatibility
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μ A at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range): 1 V at V_{DD} = 5 V
2 V at V_{DD} = 10 V 2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

duration approximately equal to the positive portion of the Q1 output. This positive overflow carry pulse can be used to enable successive cascaded stages. Logic transitions at the PE or TE inputs may occur when the clock is either high or low.

The CD40160B, CD40161B, CD40162B, and CD40163B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix). The CD40161B is also supplied in the 16-lead small-outline package (NSR suffix).

The CD40160B through CD40163B types are functionally equivalent to and pin-compatible with the TTL counter series 74LS160 through 74LS163 respectively.



Applications:

- Programmable binary and decade counting
- Counter control/timers
- Frequency dividing

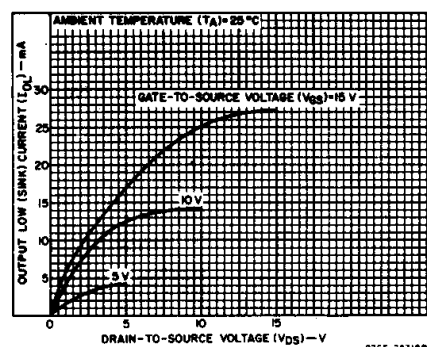


Fig. 1—Typical output low (sink) current characteristics.

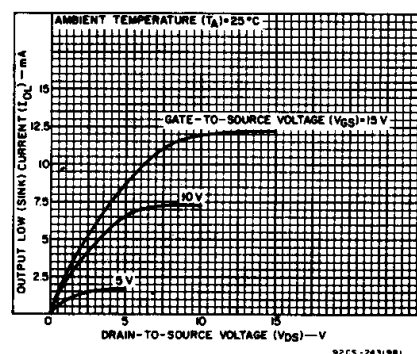


Fig. 2—Minimum output low (sink) current characteristics.

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal) -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to V_{DD} +0.5V

DC INPUT CURRENT, ANY ONE INPUT ± 10 mA

POWER DISSIPATION PER PACKAGE (P_D):

For T_A = -55°C to +100°C 500mW

For T_A = +100°C to +125°C Derate Linearly at 12mW/°C to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to +125°C

STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to +150°C

LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max +265°C

CD40160B, CD40161B, CD40162B, CD40163B Types

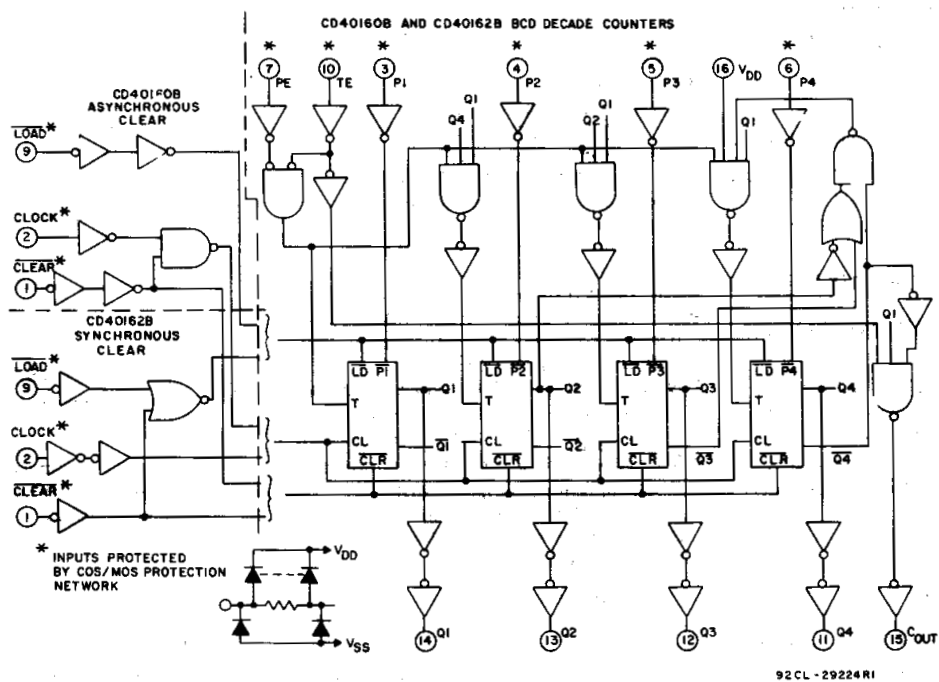


Fig. 3— Logic diagrams for CD40160B and CD40162B BCD decade counters.

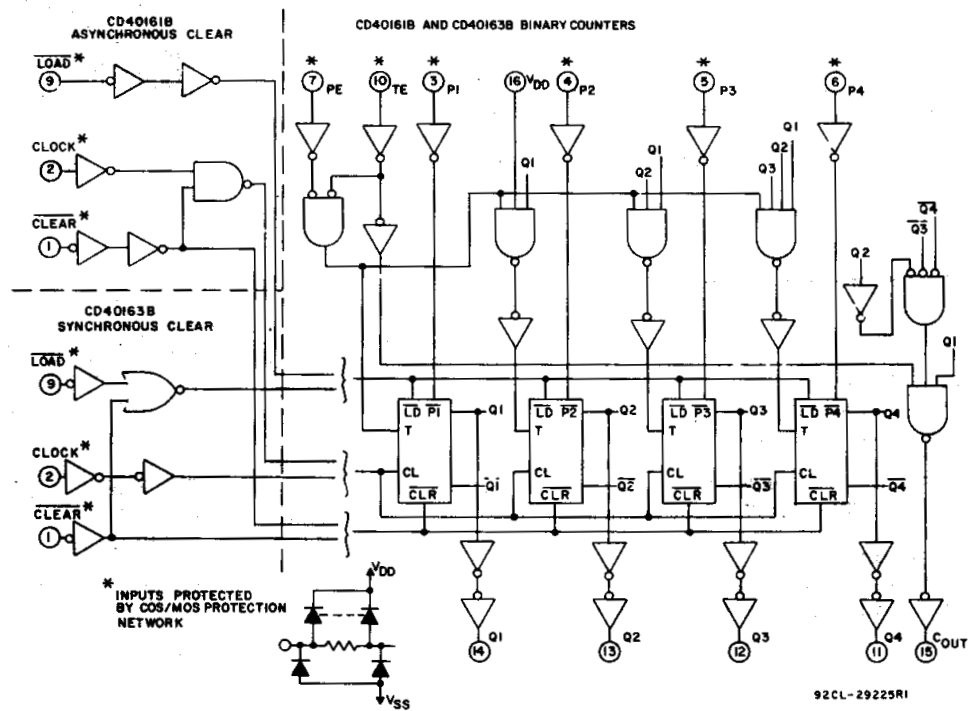


Fig. 4— Logic diagrams for CD40161B and CD40163B binary counters.

CD40160B, CD40161B, CD40162B, CD40163B Types

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^\circ\text{C}$, Except as Noted
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V_{DD} (V)	LIMITS		UNITS
		MIN.	MAX.	
Supply Voltage Range (Full T_A = Full Package-Temperature Range)	—	3	18	V
Setup Time: t_{SU} Data to Clock	5 10 15	240 90 60	— — —	ns
Load to Clock	5 10 15	240 90 60	— — —	ns
PE or TE to Clock	5 10 15	340 140 100	— — —	ns
Clear to Clock (CD40162B, CD40163B)	5 10 15	340 140 100	— — —	ns
All Hold Times, t_H	5 10 15	0 0 0	— — —	ns
Clear Removal Time, t_{rem} (CD40160B, CD40161B)	5 10 15	200 100 70	— — —	ns
Clear Pulse Width, t_{WL} (CD40160B, CD40161B)	5 10 15	170 70 50	— — —	ns
Clock Input Frequency, f_{CL}	5 10 15	— — —	2 5.5 8	MHz
Clock Pulse Width, t_W	5 10 15	170 70 50	— — —	ns
Clock Rise or Fall Time, t_{rCL} or t_{fCL}	5 10 15	— — —	200 70 15	μs

TRUTH TABLE

CLOCK	CLR	LOAD	PE	TE	OPERATION
	1	0	X	X	PRESET
	1	1	0	X	NC
	1	1	X	0	NC
	1	1	1	1	COUNT
X	0	X	X	X	RESET (CD40160B, CD40161B)
	0	X	X	X	RESET (CD40162B, CD40163B)
	1	X	X	X	NC (CD40162B, CD40163B)

1 = HIGH LEVEL 0 = LOW LEVEL X = DON'T CARE NC = NO CHANGE

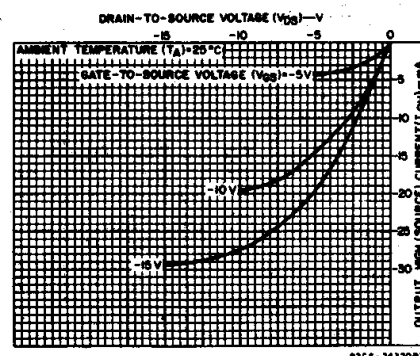


Fig. 5— Typical output high (source) current characteristics.

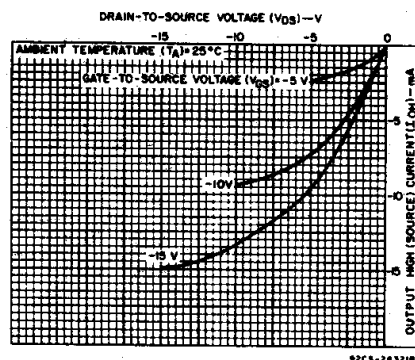


Fig. 6— Minimum output high (source) current characteristics.

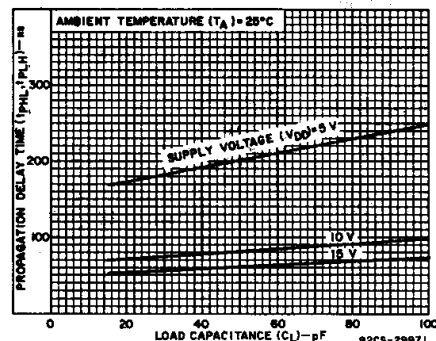


Fig. 7— Typical propagation delay time as a function of load capacitance (CLOCK to Q).

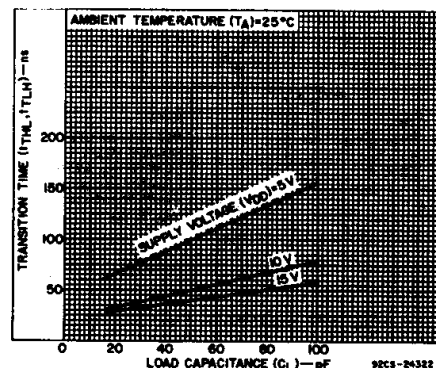


Fig. 8— Typical transition time as a function of load capacitance.

CD40160B, CD40161B, CD40162B, CD40163B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent Device Current, I _{DD} Max.	—	0,5	5	5	5	150	150	—	0.04	5	μA
	—	0,10	10	10	10	300	300	—	0.04	10	
	—	0,15	15	20	20	600	600	—	0.04	20	
	—	0,20	20	100	100	3000	3000	—	0.08	100	
Output Low (Sink) Current I _{OL} Min.	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Output High (Source) Current, I _{OH} Min.	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	
Output Voltage: Low-Level, V _{OL} Max.	—	0,5	5	0.05				—	0	0.05	V
	—	0,10	10	0.05				—	0	0.05	
	—	0,15	15	0.05				—	0	0.05	
Output Voltage: High-Level, V _{OH} Min.	—	0,5	5	4.95				4.95	5	—	V
	—	0,10	10	9.95				9.95	10	—	
	—	0,15	15	14.95				14.95	15	—	
Input Low Voltage V _{IL} Max.	0.5,4.5	—	5	1.5				—	—	1.5	V
	1,9	—	10	3				—	—	3	
	1.5,13.5	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	0.5,4.5	—	5	3.5				3.5	—	—	V
	1,9	—	10	7				7	—	—	
	1.5,13.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA

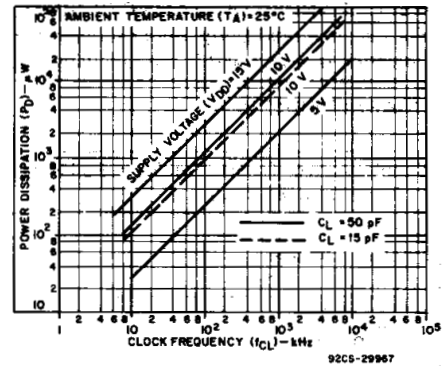


Fig. 9— Typical power dissipation as a function of CLOCK frequency.

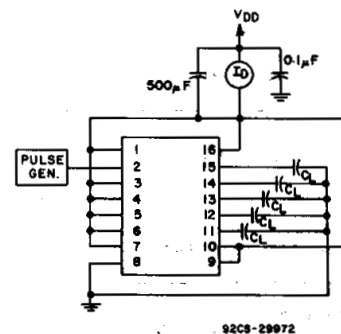


Fig. 10— Dynamic power dissipation test circuit.

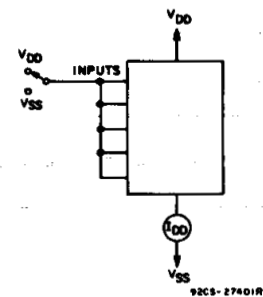


Fig. 11— Quiescent-device-current test circuit.

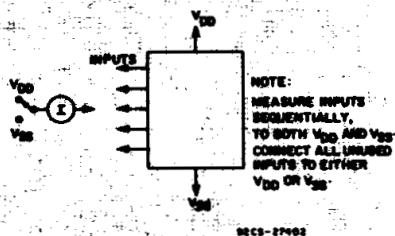


Fig. 12— Input-current test circuit.

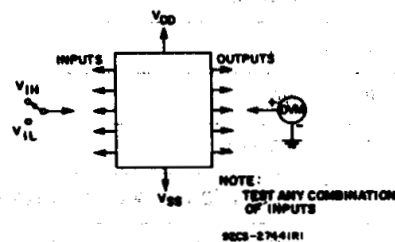
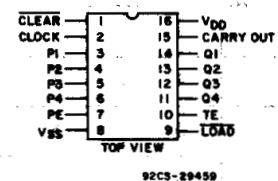


Fig. 13— Input-voltage test circuit.

TERMINAL ASSIGNMENT



CD40160B, CD40161B, CD40162B, CD40163B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$;
Input $t_r, t_f = 20\text{ ns}$, $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS V _{DD} (V)	LIMITS ALL TYPES*			UNITS
		Min.	Typ.	Max.	
CLOCK OPERATION					
Propagation Delay Time, t _{PHL} , t _{PLH} Clock to Q	5	—	200	400	ns
	10	—	80	160	
	15	—	60	120	
Clock to C _{OUT}	5	—	225	450	ns
	10	—	95	190	
	15	—	70	140	
TE to C _{OUT}	5	—	125	250	ns
	10	—	55	110	
	15	—	40	80	
Minimum Setup Time, t _{SU} Data to Clock	5	—	120	240	ns
	10	—	45	90	
	15	—	30	60	
Load to Clock	5	—	120	240	ns
	10	—	45	90	
	15	—	30	60	
PE to TE to Clock	5	—	170	340	ns
	10	—	70	140	
	15	—	50	100	
Minimum Hold Time, t _H	5	—	—	0	ns
	10	—	—	0	
	15	—	—	0	
Transition Time, t _{THL} , t _{TLH}	5	—	100	200	ns
	10	—	50	100	
	15	—	40	80	
Minimum Clock Pulse Width, t _W	5	—	85	170	ns
	10	—	35	70	
	15	—	25	50	
Maximum Clock Frequency, f _{CL}	5	2	3	—	MHz
	10	5.5	8.5	—	
	15	8	12	—	
Maximum Clock Rise or Fall Time, † t _{rCL} , t _{fCL}	5	200	—	—	μs
	10	70	—	—	
	15	15	—	—	
CLEAR OPERATION					
Propagation Delay Time, t _{PHL} (CD40160B, CD40161B) Clear to Q	5	—	250	500	ns
	10	—	110	220	
	15	—	80	160	
Minimum Setup Time, t _{SU} (CD40162B, CD40163B) Clear to Clock	5	—	170	340	ns
	10	—	70	140	
	15	—	50	100	
Minimum Hold Time, t _H (CD40162B, CD40163B) Clear to Clock	5	—	—	0	ns
	10	—	—	0	
	15	—	—	0	
Minimum Clear Removal Time, t _{rem} (CD40160B, CD40161B)	5	—	100	200	ns
	10	—	50	100	
	15	—	35	70	
Minimum Clear Pulse Width, t _{WL} (CD40160B, CD40161B)	5	—	85	170	ns
	10	—	35	70	
	15	—	25	50	

* Except as noted.

† If more than one unit is cascaded in the parallel clocked application, t_{rCL} should be made less than or equal to the sum of the fixed propagation delay at 50 pF and the transition time of the carry output driving stage for the estimated capacitive load.

CD40160B, CD40161B, CD40162B, CD40163B Types

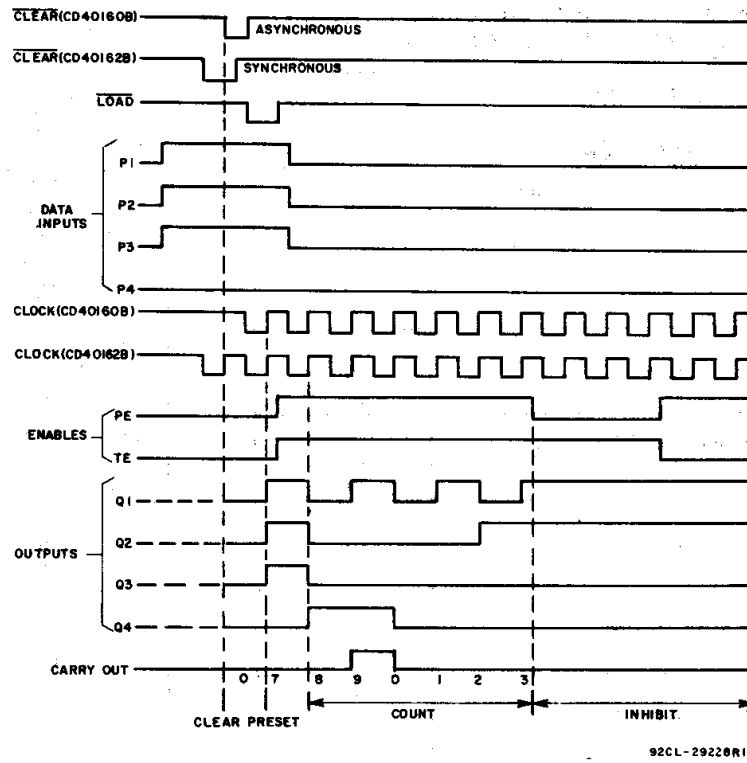


Fig. 14— Timing diagram for CD40160B, CD40162B.

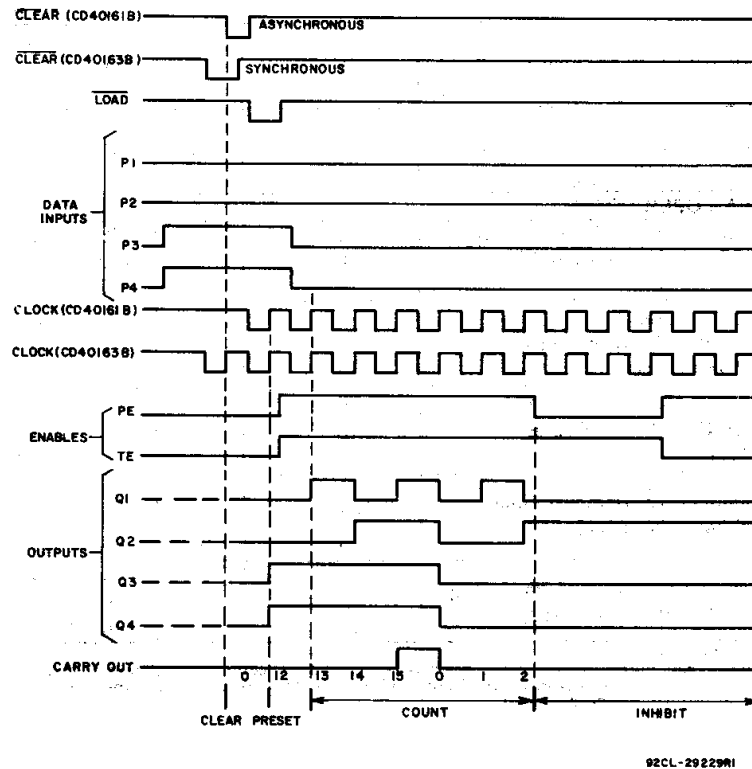


Fig. 15— Timing diagram for CD40161B, CD40163B.

CD40160B, CD40161B, CD40162B, CD40163B Types

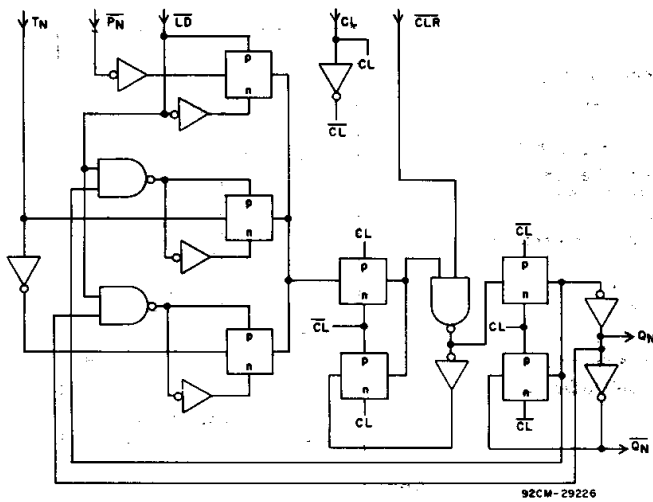


Fig. 16— Detail of flip-flops of CD40160B and CD40161B (asynchronous clear).

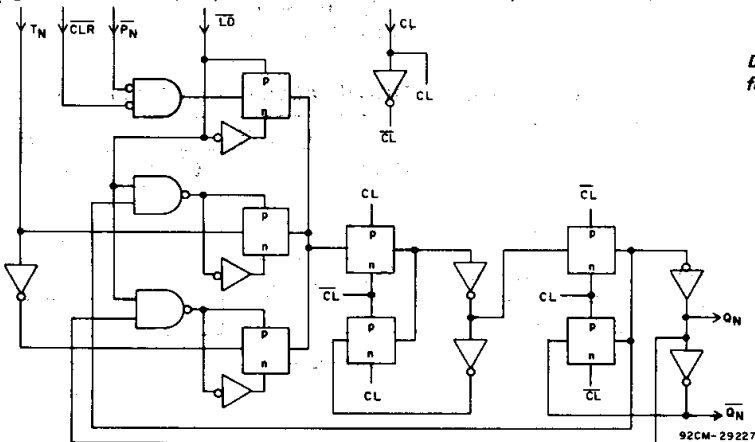
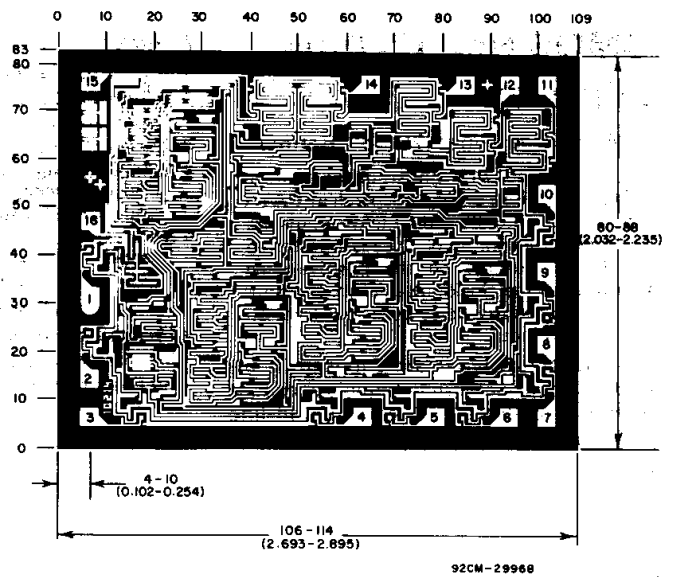


Fig. 17— Detail of flip-flops for CD40162B and CD40163B (synchronous clear).



Dimensions and pad layout for CD40160BH. Dimensions and pad layout for CD40161BH, CD40162BH, and CD40163BH are identical.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

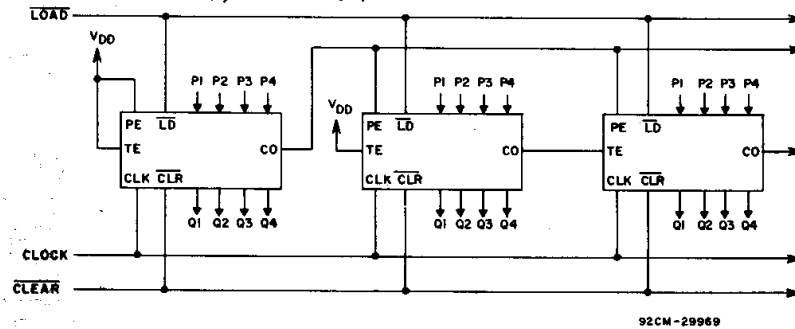


Fig. 18 — Cascaded counter packages in the parallel-clocked mode.

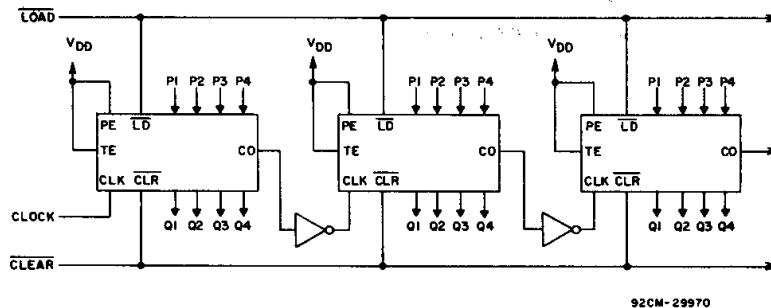


Fig. 19 — Cascaded counter packages in the ripple-clocked mode.

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